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Trudi Thompson

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| Appl No. | : | 10/540,337 | Confirmation No. 1291 |
| Applicant | : | Jan Schroers et al. | |
| Filed | : | November 7, 2005 | |
| Title | : | PT-BASE BULK SOLIDIFYING AMORPHOUS ALLOYS | |
| TC/A.U. | : | 1793 | |
| Examiner | : | George P. Wyszomierski | |
| Docket No. | : | L2:00555 | |
| Customer No. | : | 71897 | |

SUPPLEMENTAL INFORMATION DISCLOSURE STATEMENT § 1.97(b)

MAIL STOP AMENDMENT
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

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Irvine, CA 92623
June 25, 2008

Commissioner

In compliance with the duty of disclosure under 37 C.F.R. §§ 1.56, 1.97 and 1.98, and in accordance with the provisions in the MPEP §§ 609 and 707.05(b), enclosed is FORM PTO/SB/08A/B with a listing of references that are known to applicant. Copies of each of the references listed under "Foreign Patent Documents" and "Other Documents" are enclosed.

It is respectfully requested that these references be considered in the examination of this application and identified on the list of references cited on the patent issuing on this application. Applicant also requests that an initialled copy of said

Application No. 10/540,337
Supplemental Information Disclosure Statement

FORM PTO/SB/08A/B be entered in the application file, and returned to the Applicant with the next official communication from the Office in accordance with MPEP § 609.

The \$180 processing fee will be paid via credit card. If there are any other fees due in connection with this filing, the Commissioner is authorized to charge Deposit Account 50-4407. Please show our docket number with any charge to the Deposit Account.

Respectfully submitted,

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enclosures